



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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TO  
PCK

COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△									
△									
△									

APPLICABLE STANDARD				SPECIFICATIONS			
OPERATING TEMPERATURE RANGE	-55 °C TO 85 °C <sup>(1)</sup>	STORAGE TEMPERATURE RANGE	-10 °C TO 60 °C <sup>(2)</sup>	OPERATING HUMIDITY RANGE	40 % TO 80 %	STORAGE HUMIDITY RANGE	40 % TO 70 % <sup>(2)</sup>
VOLTAGE	125 V AC						
CURRENT	0.5 A						

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION				
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X

ELECTRICAL CHARACTERISTICS				
CONTACT RESISTANCE	100 mA (DC OR 1000 HZ).	45 mΩ MAX.	X	
MILLIVOLT LEVEL METHOD	20 mV MAX, 1 mA(DC OR 1000Hz)	55 mΩ MAX.	X	
INSULATION RESISTANCE	250 V DC.	100 MΩ MIN.	X	
VOLTAGE PROOF	300 V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	

MECHANICAL CHARACTERISTICS				
MECHANICAL OPERATION	500 TIMES INSERTIONS AND EXTRACTATIONS.	① CONTACT RESISTANCE: 55 mΩ MAX. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	
VIBRATION	FREQUENCY 10 TO 55 Hz, AMPLITUDE : 1.52 mm, AT 2 h FOR 3 DIRECTION.	① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	
SHOCK	490 m/s <sup>2</sup> , DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.		X	

ENVIRONMENTAL CHARACTERISTICS				
DAMP HEAT (STEADY STATE)	EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.	① CONTACT RESISTANCE: 55 mΩ MAX. ② INSULATION RESISTANCE: 100 MΩ MIN.	X	
RAPID CHANGE OF TEMPERATURE	TEMPERATURE-55→+15~+35→+85→+15~+35°C TIME 30 → 10~15 → 30 → 10~15 min UNDER 5 CYCLES.	③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	
CORROSION SALT MIST	EXPOSED IN 5 % SALT WATER SPRAY FOR 48 h.	① CONTACT RESISTANCE: 55 mΩ MAX. ② NO HEAVY CORROSION.	X	
HYDROGEN SULPHIDE	EXPOSED IN 3 PPM FOR 96 h. (TEST STANDARD: JEIDA-38)		X	
RESISTANCE TO SOLDERING HEAT	1) SOLDER BATH: SOLDER TEMPERATURE, 260±5°C FOR IMMERSION, DURATION, 10±1s. 2) SOLDERING IRONS : 360°C FOR 5 s.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINAL.	X	
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 2s.	A NEW UNIFORM COATING OF SOLDER SHALL OVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSIED.	X	

REMARKS	DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED
1) TEMPERATURE RISE INCLUDED WHEN ENERGIZED. 2) THIS STORAGE INDICATES A LONG-TERM STORAGE STATE FOR THE UNUSED PRODUCT BEFORE THE BOARD MOUNTED. Unless otherwise specified, refer to MIL-STD-1344.	1 OKAYAMA 04.06.11	K NAKAMURA 04.06.11	H Okawa 04.06.14	H Okawa 04.06.14	

Note QT: Qualification Test AT: Assurance Test X: Applicable Test

CODE NO.(OLD)	DRAWING NO.	SPECIFICATION SHEET	PART NO.
CL	ELC4 - 151041-21		FX2B-**PA-1. 27DSL (71)
			CL 572
			FORM No.231-1

